## **Polishing Pitches**

Polishing pitches are characterized by hardness. The hardness is defined as temperature in  $^{\circ}$ C, to which the pitch should be warmed up, so that a needle with diameter of 1mm penetrates into the pitch for 2mm at 10 seconds under the pressure of one kilogram-force. We offer polishing pitches with the hardness from 20 $^{\circ}$ C up to 45 $^{\circ}$ C. The polishing pitches can be produced as pure material as well as with implantation of polishing powders, what changes the abrasive properties of the polishing pitches.



pitch	description	price, EUR/kg
OXAPA PP20 OXAPA PP25 OXAPA PP30 OXAPA PP35 OXAPA PP40 OXAPA PP45	hardness 20°C, dropping point 65°C-75°C (by Ubbelohde) hardness 25°C, dropping point 65°C-75°C (by Ubbelohde) hardness 30°C, dropping point 75°C-90°C (by Ubbelohde) hardness 35°C, dropping point 75°C-90°C (by Ubbelohde) hardness 40°C, dropping point 85°C-95°C (by Ubbelohde) hardness 45°C, dropping point 85°C-95°C (by Ubbelohde)	30
Gugolz 55 Gugolz 64 Gugolz 73 Gugolz 82 Gugolz 91		34
PG Pitch 915		48

## **Wax Blocking Pitch**

pitch	description	price, EUR/kg
OXAPA WBP	blocking pitch based on wax with colophonium melting temparature ca. 60°C	31

## **Synthetic Blocking Pitch**

The synthetic blocking pitch OXAPA SBP allows to block glass substrates onto a mounting block for further processing. One heats the mounting block up to ca. 80°C, presses the synthetic pitch agains the mounting block and melts it uniformly. Afterwards one presses the glass substrates onto the mounting block and cools down to room temperature. One reheats the mounting block to remove the glass subtrates after processing. The blocking technology should be adapted for each glass family.



pitch	description	price, EUR/pc
OXAPA SBP	synthetic blocking pitch melting temparature ca. 80°C size dia 22 x 180mm, weight 90g	47